Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	3054	257/516,528,533,536-538.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/15 12:30
L2		338/22.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/15 12:30
L3	2945	347/54,56,61,62,64,67.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/15 13:06
L4	1	1 and 3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/15 12:30
L5	34	(ion with implantat\$4) same ((segment array) with (heater resistor))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/15 12:32
L6	1	1 and 5	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/15 12:32
L7	399	(ion with implantat\$4) and 1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/15 12:32
L8	231	((change alter with value)) and 7	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/15 12:33
L9	53	((change alter) with value) and 7	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/15 12:35
L10	0	((micro with heater) same (ion with implantat\$3)) same plural\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/15 12:36
L11	21	((heater) same (ion with implantat\$3)) same plural\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/15 12:46

L12	13	((heater and wire) with pattern) and (ion with implantat\$3)	US-PGPUB; USPAT;	OR	ON	2006/07/15 12:51
			USOCR; EPO; JPO; DERWENT; IBM_TDB			
L13	1	2004-511752.NRAN.	DERWENT	OR	ON	2006/07/15 12:51
L14	1	2004-511752.NRAN.	DERWENT	OR	ON	2006/07/15 12:51
L15	56	(((heater resistor) and wire) with pattern) and (ion with implantat\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/15 12:52
L16	43	15 not 12	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/15 13:00
L17	3	(electric\$2 with (wire with heater)) same (ion with implantat\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/15 13:01
L18	11	((electric\$2 with resistance) same (wire with heater)) and (ion with implantat\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/15 13:07
L19	335	347/62.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/15 13:06
L20	6278	resistance with wire with heater	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TD8	OR	ON	2006/07/15 13:06
L21	8	19 and 20	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR .	ON	2006/07/15 13:06
L22	11	(heater with pattern) same (ion with implantat\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/15 13:32
L23	10	(ion with implantat\$3) and 19	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/15 13:31
L24	0	(heater with (pattern with dop\$3)) and 19	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/15 13:33

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L25	0	(heater with (pattern same dop\$3)) and 19	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/15 13:33
L26	86	(heater with (pattern)) and 19	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/15 13:33
L27	14	(heater with (pattern with resistance)) and 19	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/15 13:33
S1	2	"20040160486"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/15 15:44
S2	1	2004-511752.NRAN.	DERWENT	OR	ON	2005/11/15 15:43
53	34	(wire with heater) with dop\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/15 15:45
S4	2	S3 and ink\$3jet	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/15 15:45
S5	35	(wire same heater) with dop\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/15 15:46
S6	1	S5 and (ink with jet)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/15 15:45
S7	1	S3 and (ink with jet)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/15 15:46
<b>58</b>	43	(wire and heater) with dop\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/15 15:46
S9	366	(wire and heater) same dop\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/15 15:47
S10	. 63983	"347"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/15 15:46

S11	51	S9 and S10	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/15 16:15
S12	17	(wire and heater) same (dop\$3 with (resistor resistive))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/15 15:47
S13	821	347/56.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/15 16:15
S14	311	347/62.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/15 16:19
S15	264	wir\$3 with integrat\$3 with heater	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/15 16:16
S16	9	S14 and S15	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/15 16:15
S17	20658	wir\$3 near4 heater	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/15 16:16
S18	193	S15 and S17	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/15 16:16
S19	12	S18 and dop\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/15 16:16
S20	23163	heat\$3 with dop\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/15 16:19
S21	22	S14 and S20	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/15 16:19
S22	2768	347/54,56,61,62,64,67.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/05 07:24

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S23	12345	(ion with implantation) same dopant	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/15 12:31
524	19	S22 and S23	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/05 07:30
S25	6476	(wire and heater) with (layer pattern substrate)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/05 07:37
S26	42	S23 and S25	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/05 07:31
S27	18	S26 and (ink with jet)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/05 07:31
S28	604	((lon with implantation) with dopant) same (wir\$3 lead connect\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/05 07:33
S29	64573	"347"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/05 07:33
S30	11	S28 and S29	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/05 07:36
S31	41	S23 and S29	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR .	ON	2006/01/05 07:36
S32	3394	(wire with heater) with (layer pattern substrate)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/05 07:37
533	11	S31 and S32	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/05 07:37
S34	7	("4532530"   "4774530"   "4935752"   "4951063"   "5636441"   "5742307"   "Re32572").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/01/05 07:43

535	0	S23 and S34	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/05 07:43
536	5	(ion implantation dopant) and S34	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/05 07:46
S37	13	("5636441").URPN.	USPAT	OR	ON	2006/01/05 07:46
S38	7	(ion implantation dopant) and S37	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/05 07:47
S39	7745	(ion adj implantation) with dopant	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/05 07:48
S40	37	S29 and S39	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/05 07:48
S41	67063	"347"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/14 12:10
S42	162	(heater resistor) with (wire and dop\$3 and area) .	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/14 12:11
S43	4	S41 and S42	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/14 12:11
S44	1144	((multiple plural\$3) near4 (wire lead)) with (heater termistor)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/14 12:12
S45	50	S41 and S44	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/14 12:14
S46	335	347/62.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/14 12:14
S47	10	(ion with implantat\$3) and S46	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/14 12:56

S48	2253	257/536-538.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/14 13:03
S49	49	(wire and (heater)) with dop\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/14 12:56
S50	0	S48 and S49	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/14 12:56
S51	89993	(ion with implantat\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/14 13:12
S52	295	S48 and S51	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/14 12:57
S53	520	(heater resistor) with (dop\$3 with area)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/14 13:05
S54	22	S52 and S53	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/14 13:02
S55	12	S41 and S48	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/14 13:02
S56	3054	257/516,528,533,536-538.cds.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/14 13:03
S57	13	S41 and S56	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/14 13:04
S58	2	S51 and S57	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/14 13:04
559	828	(heater thermal) with (dop\$3 with area)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/14 13:05

S60	2	S48 and S59	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/14 13:05
S61	39	(ion with implantat\$3) same ((plural43 multiple) with (resistance resistor))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/14 13:13
S62	1	(ion with implantat\$3) same ((plural43 multiple) with (resistance resistor)) and heater	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/14 13:13
S63	7	("4021277"   "4196228"   "4225877"   "4510178"   "4520342"   "4597163"   "4682143").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/07/14 13:17
S64	16	("4759836").URPN.	USPAT	OR	ON	2006/07/14 13:18
S65	14	S64 and (ta tantalum metal)	USPAT	OR	ON	2006/07/14 13:19
S66	7	S64 and (ta tantalum)	USPAT	OR	ON	2006/07/14 13:19

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